Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

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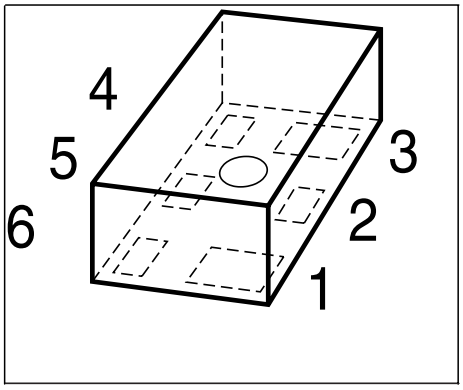
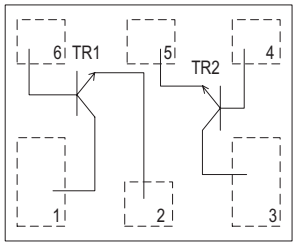
NPN Silicon RF Transistor

Preliminary data

- Low voltage/ low current operation
- For low noise amplifiers
- For oscillators up to 3.5 GHz and Pout > 10 dBm
- Low noise figure: TR1: 1.0dB at 1.8 GHz
  TR2: 1.1 dB at 1.8 GHz
- Built in 2 Transistors (TR1: die as BFR360L3,
  TR2: die as BFR380L3)





ESD: **E**lectro**s**tatic **d**ischarge sensitive device, observe handling precaution!

Type	Marking	Pin Configuration						Package
BFS386L6	FD	1=C1	2=E1	3=C2	4=B2	5=E2	6=B1	TSLP-6-1

Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-emitter voltage	V_{CEO}		V
TR1		6	
TR2		6	
Collector-emitter voltage	V_{CES}		
TR1		15	
TR2		15	
Collector-base voltage	V_{CBO}		
TR1		15	
TR2		15	
Emitter-base voltage	V_{EBO}		
TR1		2	
TR2		2	
Collector current	I_C		mA
TR1		35	
TR2		80	

Maximum Ratings

Parameter	Symbol	Value	Unit
Base current	I_B		mA
TR1		4	
TR2		14	
Total power dissipation[1)]	P_{tot}		mW
$T_S \leq 101°C$, TR1		210	
$T_S \leq 96°C$, TR2		380	
Junction temperature	T_j		°C
TR1		150	
TR2		150	
Ambient temperature	T_A		
TR1		-65 ... 150	
TR2		-65 ... 150	
Storage temperature	T_{stg}		
TR1		-65 ... 150	
TR2		-65 ... 150	

Thermal Resistance

Parameter	Symbol	Value	Unit
Junction - soldering point[2)]	R_{thJS}		K/W
TR1		≤ 230	
TR2		≤ 140	

[1] T_S is measured on the collector lead at the soldering point to the pcb

[2] For calculation of R_{thJA} please refer to Application Note Thermal Resistance

Electrical Characteristics at T_A = 25°C, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
DC Characteristics					
Collector-emitter breakdown voltage	$V_{(BR)CEO}$				V
TR1, I_C = 1 mA, I_B = 0		6	9	-	
TR2, I_C = 1mA, I_B = 0		6	9	-	
Collector-emitter cutoff current	I_{CES}				µA
TR1, V_{CE} = 15 V , V_{BE} = 0		-	-	10	
TR2, V_{CE} = 15 V , V_{BE} = 0		-	-	10	
Collector-base cutoff current	I_{CBO}				nA
TR1, V_{CB} = 5 V, I_E = 0		-	-	100	
TR2, V_{CB} = 5 V, I_E = 0		-	-	100	
Emitter-base cutoff current	I_{EBO}				µA
TR1, V_{EB} = 1 V, I_C = 0		-	-	1	
TR2, V_{EB} = 1 V, I_C = 0		-	-	1	
DC current gain-	h_{FE}				-
TR1, I_C = 15 mA, V_{CE} = 3 V		60	130	200	
TR2, I_C = 40 mA, V_{CE} = 3 V		60	130	200	

Electrical Characteristics at T_A = 25°C, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
AC Characteristics (verified by random sampling)					
Transition frequency	f_T				GHz
TR1, I_C = 15 mA, V_{CE} = 3 V, f = 1 GHz		-	14	-	
TR2, I_C = 40 mA, V_{CE} = 3 V, f = 1 GHz		-	14	-	
Collector-base capacitance	C_{cb}				pF
TR1, V_{CB} = 5 V, f = 1 MHz, emitter grounded		-	0.3	-	
TR2, V_{CB} = 5 V, f = 1 MHz, emitter grounded		-	0.5	-	
Collector emitter capacitance	C_{ce}				
TR1, V_{CE} = 5 V, f = 1 MHz, base grounded		-	0.15	-	
TR2, V_{CE} = 5 V, f = 1 MHz, base grounded		-	0.2	-	
Emitter-base capacitance	C_{eb}				
TR1, V_{EB} = 0,5 V, f = 1 MHz, collector grounded		-	0.43	-	
TR2, V_{EB} = 0,5 V, f = 1 MHz, collector grounded		-	1.1	-	

Electrical Characteristics at TA = 25°C, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
AC Characteristics (verified by random sampling)					
Noise figure	F				dB
TR1, I_C = 3 mA, V_{CE} = 3 V, Z_S = Z_{Sopt} ,					
f = 1.8 GHz		-	1	-	
TR1, I_C = 3 mA, V_{CE} = 3 V, Z_S = Z_{Sopt} ,					
f = 3 GHz		-	1.6	-	
TR2, I_C = 8 mA , V_{CE} = 3 V, Z_S = Z_{Sopt} ,					
f = 1.8 GHz		-	1.3	-	
TR2, I_C = 8 mA , V_{CE} = 3 V, Z_S = Z_{Sopt} ,					
f = 3 GHz		-	1.9	-	
Power gain, maximum available[1)]	G_{ma}				
TR1, I_C = 15 mA, V_{CE} = 3 V, f = 1.8 GHz		-	14.5	-	
TR1, I_C = 15 mA, V_{CE} = 3 V, f = 3 GHz		-	10	-	
TR2, I_C = 40 mA, V_{CE} = 3 V, f = 1.8 GHz		-	12	-	
TR2, I_C = 40 mA, V_{CE} = 3 V, f = 3 GHz		-	8	-	
Transducer gain	$\lvert S_{21e}\rvert^2$				
TR1, I_C = 15 mA, V_{CE} = 3 V, f = 1.8 GHz		-	12	-	
TR1, I_C = 15 mA, V_{CE} = 3 V, f = 3 GHz		-	8	-	
TR2, I_C = 15 mA, V_{CE} = 3 V, f = 1.8 GHz		-	10	-	
TR2, I_C = 15 mA, V_{CE} = 3 V, f = 3 GHz		-	6	-	
Third order intercept point at output[2)]	IP_3				dBm
TR1, V_{CE} = 3 V, I_C = 15 mA, f = 1.8 GHz		-	24	-	
TR2, V_{CE} = 3 V, I_C = 40 mA, f = 1.8 GHz		-	27	-	
1dB Compression point	P_{-1dB}				
TR1, I_C = 15 mA, V_{CE} = 3 V, f = 1.8 GHz		-	9	-	
TR2, I_C = 40 mA, V_{CE} = 3 V, f = 1.8 GHz		-	11.5	-	

[1] $G_{ma} = \lvert S_{21e} / S_{12e}\rvert \, (k-(k^2-1)^{1/2})$

[2] IP3 value depends on termination of all intermodulation frequency components.
Termination used for this measurement is 50Ω from 0.1 MHz to 6 GHz